

### **General Description**

The SM4364NAKPC-TRG use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable.

#### **General Features**

V<sub>DS</sub> =30V l<sub>D</sub> =82A

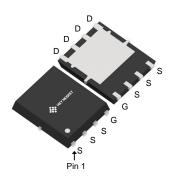
 $R_{DS(ON)}$  < 6.2m $\Omega$ @  $V_{GS}$ =10V

## **Applications**

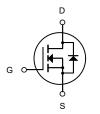
Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications



DFN5X6-8L (PDFN-8(5x6))



N-Channel MOSFET

**Package Marking and Ordering Information** 

Product ID	Pack	Brand	Qty(PCS)
SM4364NAKPC-TRG	DFN5X6-8L(PDFN-8(5x6))	HXY MOSFET	5000

Absolute Maximum Ratings (T<sub>C</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter	Rating	Units
V <sub>D</sub> S	Drain-Source Voltage	Drain-Source Voltage 30	
Vgs	V <sub>GS</sub> Gate-Source Voltage		V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	82	А
I <sub>D</sub> @T <sub>C</sub> =100°C	@T <sub>C</sub> =100C Continuous Drain Current, V <sub>GS</sub> @ 10V		А
Ідм	IDM Pulsed Drain Current <sup>2</sup>		А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	38.8	mJ
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	37	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀Jc	Thermal Resistance from Junction-to-Ambient <sup>3</sup>	4.6	°C/W
R <sub>θJA</sub> Thermal Resistance Junction-Ambient <sup>1</sup>		50	°C/W

### N-SGT Enhancement Mode MOSFET

### Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =20A		4.3	6.2	$-$ m $\Omega$	
NDS(ON)	Static Diam-Source On-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		5.7	8	1112.2	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2		2.5	V	
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA	
IDSS		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5		
Igss	I <sub>GSS</sub> Gate-Source Leakage Current V <sub>GS=±20V</sub> , V <sub>DS</sub> =0V				±100	nA	
gfs	gfs Forward Transconductance V <sub>DS</sub> =5V , I <sub>D</sub> =20A			67		S	
Rg	R <sub>g</sub> Gate Resistance V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz			1.7		Ω	
Qg	Total Gate Charge (4.5V)			8			
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		2.4		nC	
$Q_{gd}$	Gate-Drain Charge			3.2			
T <sub>d(on)</sub>	Turn-On Delay Time			7.1			
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$		40		20	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =15A		15		ns	
Tf	Fall Time			6			
Ciss	Input Capacitance			814			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		498		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			41			

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			82	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1	V
t <sub>rr</sub>	Reverse Recovery Time	IF=20A , di/dt=100A/μs ,		15		nS
Qrr	Reverse Recovery Charge	T <sub>J</sub> =25℃		25		nC

#### Note:

- 1. The data tested by surface mounted on a 1 inch $^2\,\text{FR-4}$  board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leqq$  300us , duty cycle  $\leqq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =24A
- 4. The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**

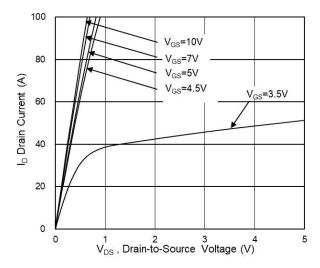


Fig.1 Typical Output Characteristics

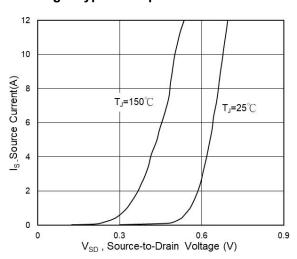


Fig.3 Source Drain Forward Characteristics

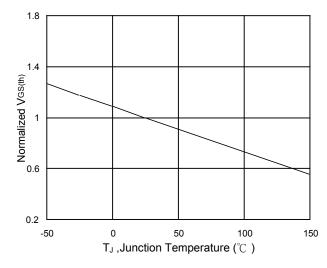


Fig.5 Normalized V<sub>GS(th)</sub> vs T<sub>J</sub>

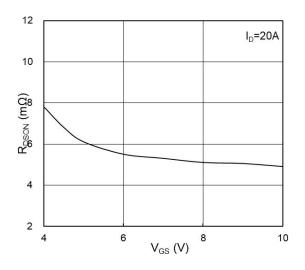


Fig.2 On-Resistance vs G-S Voltage

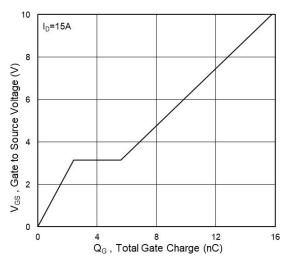


Fig.4 Gate-Charge Characteristics

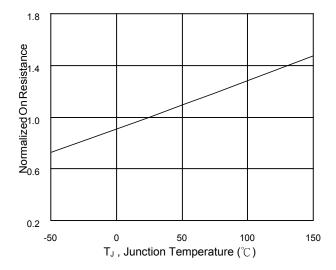
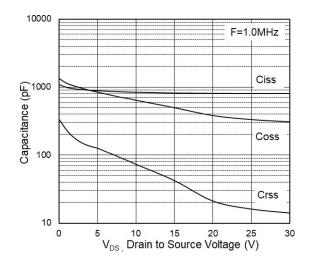


Fig.6 Normalized RDSON vs TJ



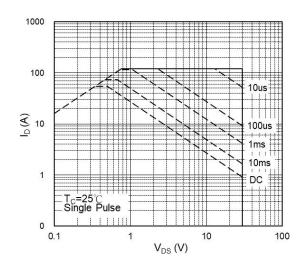


Fig.7 Capacitance

Fig.8 Safe Operating Area

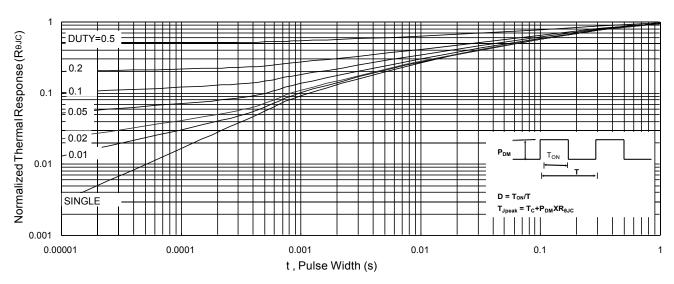


Fig.9 Normalized Maximum Transient Thermal Impedance

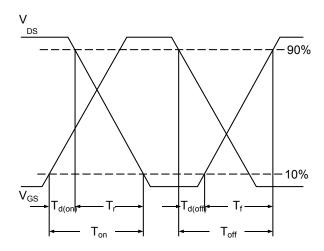


Fig.10 Switching Time Waveform

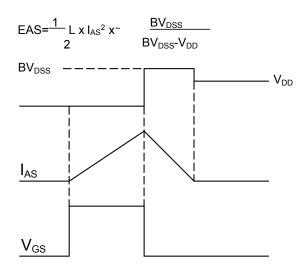
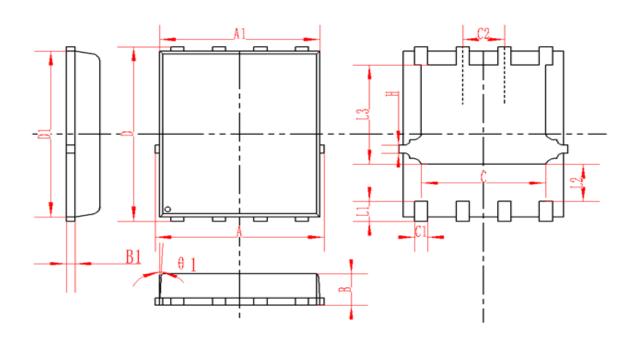


Fig.11 Unclamped Inductive Switching Waveform



# DFN5X6-8L(PDFN-8(5x6)) Package Information



SYMBOL	MM			INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.95	5	5.05	0.195	0.197	0.199	
A1	4.82	4.9	4.98	0.190	0.193	0.196	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.67	5.75	5.83	0.223	0.226	0.230	
В	0.9	0.95	1	0.035	0.037	0.039	
B1	0.254REF			0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2		1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Н	0.24	0.25	0.26	0.009	0.010	0.010	



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